

# PolarHT<sup>™</sup> Power MOSFET

# IXTQ 96N15P IXTT 96N15P

$$V_{DSS} = 150 V \\ I_{D25} = 96 A \\ R_{DS(on)} \leq 24 m\Omega$$

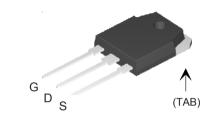
N-Channel Enhancement Mode Avalanche Rated



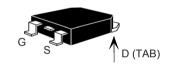
Symbol	Test Conditions	Maximum	Ratings
V <sub>DSS</sub>	T <sub>J</sub> = 25° C to 150° C	150	V
$\mathbf{V}_{DGR}$	$T_J = 25^{\circ} C$ to $150^{\circ} C$ ; $R_{GS} = 1 M\Omega$	150	V
V <sub>GSS</sub>	Continuous	±20	V
V <sub>GSM</sub>	Transient	±30	V
I <sub>D25</sub>	T <sub>C</sub> =25°C	96	Α
I <sub>D(RMS)</sub>	External lead current limit	75	Α
I <sub>DM</sub>	$T_{\rm C}$ = 25° C, pulse width limited by $T_{\rm JM}$	250	Α
I <sub>AR</sub>	T <sub>C</sub> =25°C	60	Α
E <sub>AR</sub>	T <sub>C</sub> = 25° C	40	mJ
E <sub>AS</sub>	T <sub>C</sub> = 25° C	1.0	J
dv/dt	$I_{S} \leq I_{DM}$ , di/dt $\leq 100$ A/ $\mu$ s, $V_{DD} \leq V_{DSS}$ $T_{J} \leq 150^{\circ}$ C, $R_{G} = 4$ $\Omega$	10	V/ns
$\overline{P_{D}}$	T <sub>C</sub> =25°C	480	W
T <sub>J</sub>		-55 +175	°C
T <sub>.IM</sub>		175	°C
T <sub>stg</sub>		-55 +150	°C
$T_L$	1.6 mm (0.062 in.) from case for 10 s	300	°C
T <sub>SOLD</sub>	Plastic body for 10 s	260	°C
M <sub>d</sub>	Mounting torque (TO-3P)	1.13/10	Nm/lb.in.
Weight	TO-3P TO-268	5.5 5.0	g g

<b>Symbol</b> (T <sub>J</sub> = 25° C, t	Test Conditions unless otherwise specified)		Ch Min.	_	istic Va Max	
BV <sub>DSS</sub>	$V_{GS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$		150			V
$V_{\rm GS(th)}$	$V_{DS} = V_{GS}, I_{D} = 250\mu A$		2.5		5.0	V
I <sub>GSS</sub>	$V_{GS} = \pm 20 V_{DC}, V_{DS} = 0$				±100	nA
I <sub>DSS</sub>	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$	T <sub>J</sub> = 125° C			25 250	μ <b>Α</b> μ <b>Α</b>
R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_{D} = 0.5 I_{D25}$ Pulse test, t ≤300 µs, duty (	cycle d ≤ 2 %			24	mΩ

## TO-3P (IXTQ)



## TO-268 (IXTT)



G = Gate D = Drain S = Source TAB = Drain

#### **Features**

- <sup>1</sup> International standard packages
- Unclamped Inductive Switching (UIS) rated
- <sup>1</sup> Low package inductance
  - easy to drive and to protect

#### **Advantages**

- <sup>I</sup> Easy to mount
- Space savings
- <sup>1</sup> High power density

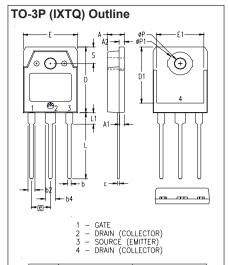


Symbo	ol	Test Conditions $(T = 25^{\circ} C)$	Characteristic Values 25° C, unless otherwise specified)		
			Min.	Typ.	Max.
$g_{fs}$		$V_{DS}$ = 10 V; $I_{D}$ = 0.5 $I_{D25}$ , pulse test	35	45	S
C <sub>iss</sub>	)			3500	pF
C <sub>oss</sub>	}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		1000	pF
C <sub>rss</sub>	J			280	pF
t <sub>d(on)</sub>	)			30	ns
t <sub>r</sub>		$V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}_{DSS}, I_{D} = 60 \text{ A}$		33	ns
$\mathbf{t}_{d(off)}$		$R_{_{G}} = 4 \Omega $ (External)		66	ns
t <sub>f</sub>	)			18	ns
Q <sub>g(on)</sub>	)			110	nC
$\mathbf{Q}_{gs}$	}	$V_{GS}^{}$ = 10 V, $V_{DS}^{}$ = 0.5 $V_{DSS}^{}$ , $I_{D}^{}$ = 0.5 $I_{D25}^{}$		26	nC
$\mathbf{Q}_{gd}$	J			59	nC
R <sub>thJC</sub>					0.31° C/W
$\mathbf{R}_{thCS}$		(TO-3P)		0.21	° C/W

#### Source-Drain Diode

Characteristic Values (T, = 25°C, unless otherwise specified)

Symbol	Test Conditions	Min.	Тур.	Max.	
Is	$V_{GS} = 0 V$			96	Α
I <sub>SM</sub>	Repetitive			250	Α
V <sub>SD</sub>	$I_F = I_S$ , $V_{GS} = 0$ V, Pulse test, t ≤300 $\mu$ s, duty cycle d≤ 2 %			1.5	V
$\begin{bmatrix} \mathbf{t}_{rr} & \\ \mathbf{Q}_{RM} \end{bmatrix}$	$I_F = 25 \text{ A}, -\text{di/dt} = 100 \text{ A/}\mu\text{s}$ $V_R = 100 \text{ V}, V_{GS} = 0 \text{ V}$		150 2.0		ns μC



SYM	INCH	IES	MILLIN	METERS		
	MIN	MAX	MIN	MAX		
Α	.185	.193	4.70	4.90		
A 1	.051	.059	1.30	1.50		
A2	.057	.065	1.45	1.65		
Ь	.035	.045	0.90	1.15		
b2	.075	.087	1.90	2.20		
b4	.114	.126	2.90	3.20		
С	.022	.031	0.55	0.80		
D	.780	.799	19.80	20.30		
D1	.665	.677	16.90	17.20		
E	.610	.622	15.50	15.80		
E1	.531	.539	13.50	13.70		
е	.215	BSC	5.45	BSC		
L	.779	.795	19.80	20.20		
L1	.134	.142	3.40	3.60		
ØΡ	.126	.134	3.20	3.40		
øP1	.272	.280	6.90	7.10		
S	.193	.201	4.90	5.10		

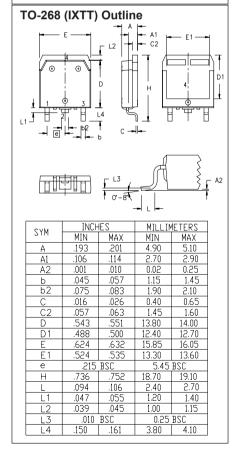


Fig. 1. Output Characteristics

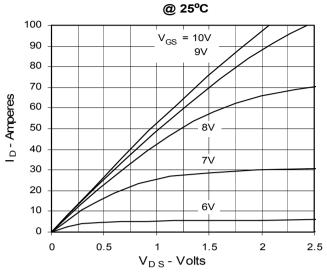


Fig. 3. Output Characteristics @ 150°C

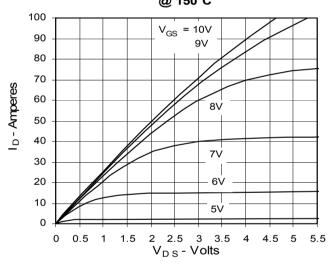


Fig. 5.  $R_{DS(on)}$  Normalized to 0.5  $I_{D25}$  Value vs.  $I_D$ 

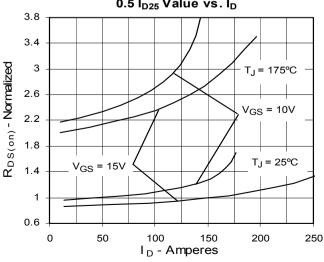


Fig. 2. Extended Output Characteristics @ 25°C

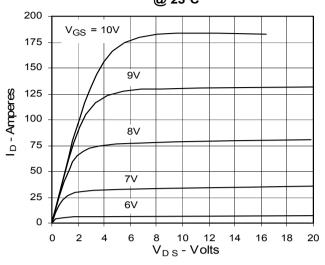


Fig. 4. R<sub>DS(on)</sub> Normalized to 0.5 I<sub>D25</sub> Value vs. Junction Temperature

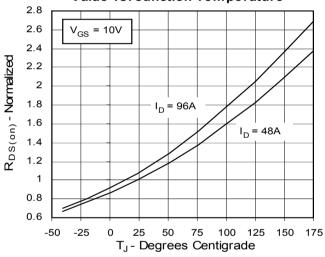
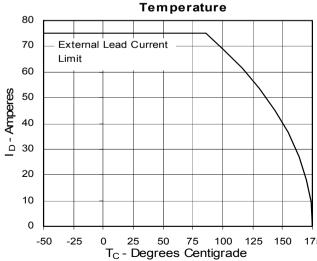


Fig. 6. Drain Current vs. Case
Temperature





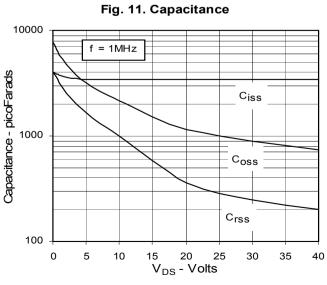
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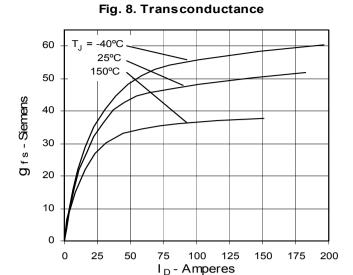
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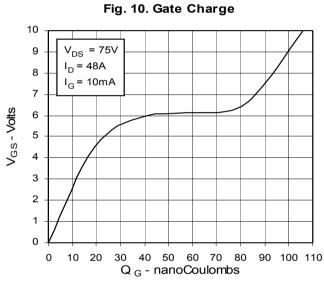
Fig. 7. Input Admittance 180 160 140 120 100 80 60 T<sub>J</sub> = 150°C 40 20

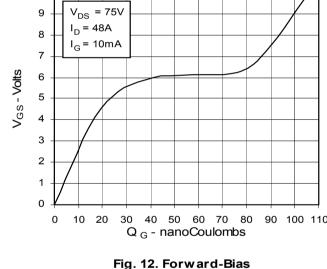
7 8 9 5 10 V<sub>GS</sub> - Volts Fig. 9. Source Current vs.

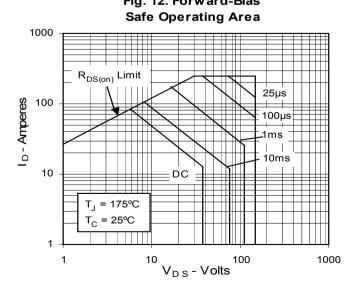
Source-To-Drain Voltage 300 250 200 Is-Amperes 150 100 T<sub>J</sub> = 150°C 50 = 25°C 0 0.4 0.6 1.8 0.8 1.2 1.4 1.6  $V_{S\,D}$  - Volts











IXYS reserves the right to change limits, test conditions, and dimensions.



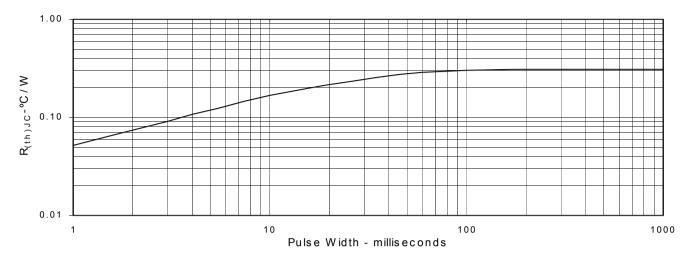


Fig. 13. Maximum Transient Thermal Resistance

